



Dual P-Channel 2.5-V (G-S) MOSFET

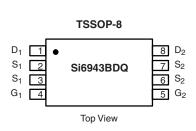
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$ $I_D(A$			
- 12	$0.08 \text{ at V}_{GS} = -4.5 \text{ V}$	- 2.5		
	0.105 at V _{GS} = - 2.5 V	- 1.9		

FEATURES

- Halogen-free Option Available
 TrenchFET® Power MOSFETs

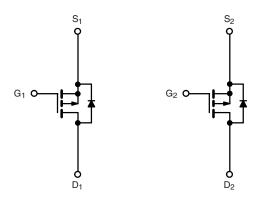


RoHS³ COMPLIANT



Ordering Information: Si6943BDQ-T1

Si6943BDQ-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	- 12		V	
Gate-Source Voltage		V _{GS}	± 8			
Continuous Drain Current /T 150 °C\8	T _A = 25 °C	- I _D	- 2.5	- 2.3		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		- 2.2	- 1.8	۸	
Pulsed Drain Current (10 µs Pulse Width)		I _{DM}	- 20		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	- 1.0	- 0.7		
Marijas um Barran Disabatis ational	T _A = 25 °C	- P _D	1.10	0.80	W	
Maximum Power Dissipation ^a	T _A = 70 °C		0.70	0.50		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manifestore baseding to Applicated	t ≤ 10 s	- R _{thJA}	89	110	°C/W
Maximum Junction-to-Ambient ^a	Steady State		120	150	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	70	90	

a. Surface Mounted on 1" x 1" FR4 board.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

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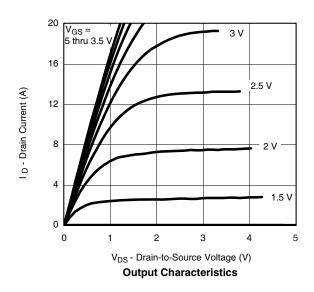
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions N		Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	- 0.45		- 0.8	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 9.6 V, V _{GS} = 0 V			- 1		
		V _{DS} = - 9.6 V, V _{GS} = 0 V, T _J = 70 °C			- 5	μΑ	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 4.5 V	- 10			Α	
	D	V _{GS} = - 4.5 V, I _D = - 2.5 A	0.06 0		0.08		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 1.9 A		0.08	0.105	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 2.5 A		8		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 1.0 A, V _{GS} = 0 V		- 0.75	- 1.2	V	
Dynamic ^b							
Total Gate Charge	Q_g			5.7	10	nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -2.5 \text{ A}$		0.8			
Gate-Drain Charge	Q_{gd}			1.6		1	
Turn-On Delay Time	t _{d(on)}			15	25		
Rise Time	t _r	V_{DD} = - 6 V, R_L = 6 Ω		35	60		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 1.0 A, $V_{GEN}=$ - 4.5 V, $R_G=6~\Omega$		35	60	ns	
Fall Time	t _f			30	50		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.0 A, dI/dt = 100 A/μs		30	60		

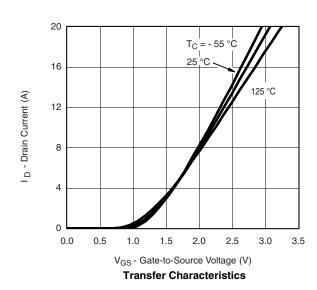
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



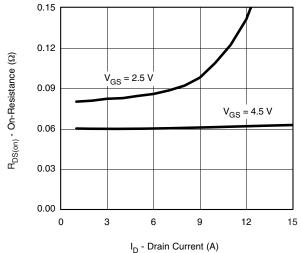




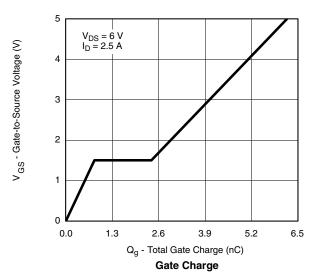


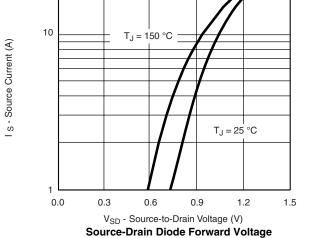


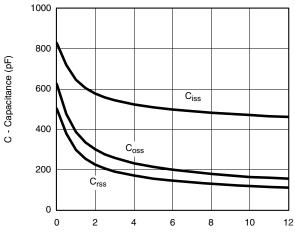
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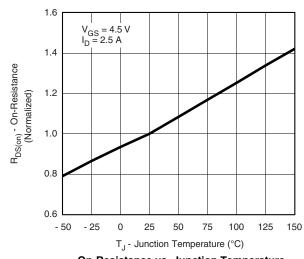
On-Resistance vs. Drain Current



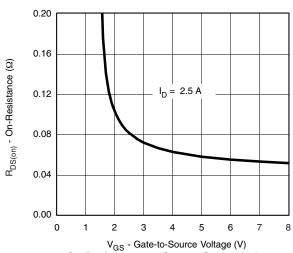




V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature



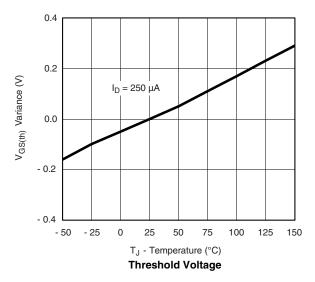
On-Resistance vs. Gate-to-Source Voltage

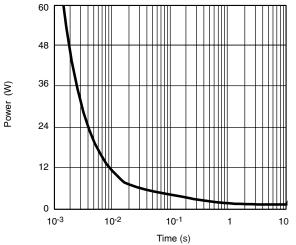
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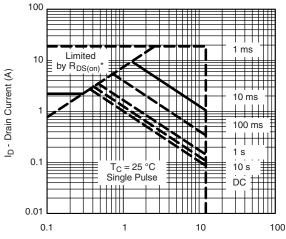
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TYPICAL CHARACTERISTICS 25 °C. unless otherwise noted

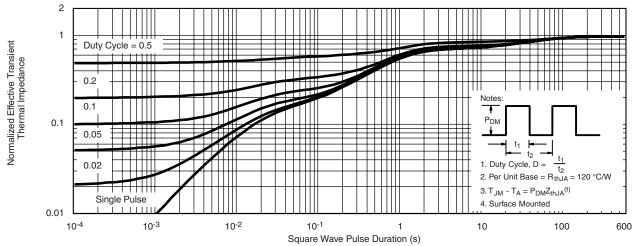




Single Pulse Power, Junction-to-Ambient

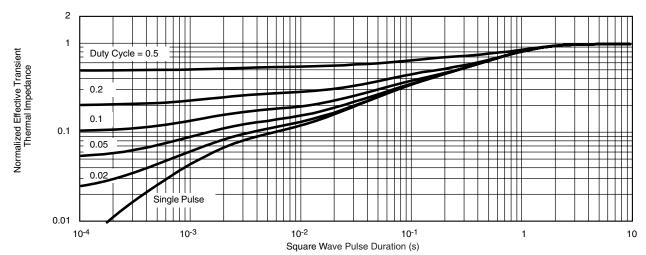


$$\begin{split} &V_{DS}\text{ - Drain-to-Source Voltage (V)}\\ ^*V_{GS}\text{ > minimum }V_{GS}\text{ at which }R_{DS(on)}\text{ is specified}\\ \textbf{Safe Operating Area, Junction-to-Case} \end{split}$$





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72016.



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